

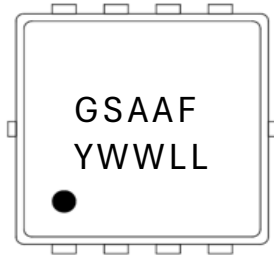
N-channel Power MOSFET:
30V, 2.1mΩ, 94A, PDFN33

Product Summary

VDS	VGSS	RDS(ON) TYP/MAX	ID MAX
30V	± 20V	2.1/2.8 mΩ@VGS=10V 3.5/5.2 mΩ@VGS=4.5V	94A

Marking Symbol Code

- ❖ Laser Marking Device Code: AA



GS : Gostone (fixed)
AA : Marking Device Code (fixed)
F : Factory Code
Y : Year Code
W : Week Code
L : LOT Code
● : Pin#1 Identifier

Form

- ❖ Tape & Reel Embossed Type: 5,000pcs / reel

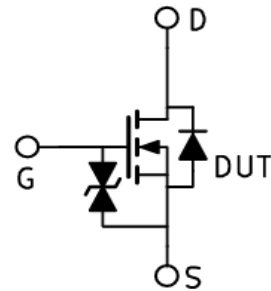
Features

- ❖ Low RDSon
- ❖ Optimized for Load Switch
- ❖ High Current Capacity
- ❖ Halogen-Free / RoHS Compliant
- ❖ ESD Protection Diode Installed (Gate-Source)

Application

- ❖ Battery Charging & Discharging for NB Battery Pack
- ❖ DC/DC Converters in Computing.

Equivalent circuit



Absolute Maximum Rating Ta=25°C

Parameter	Symbol	Rating	Unit
Drain to Source Voltage	VDS	30	V
Gate to Source Voltage	VGS	±20	V
Continuous Drain Current	IDM	94	A
		60	A
Pulsed Drain Current*1	IDM	188	A
Continuous Drain Current	IDSM	25	A
		20	A
Avalanche Current	IAS	30	A
Avalanche Energy	EAS	45.0	mJ
Power Dissipation	PD	51	W
		20	W
Power Dissipation*3	PDSM	4.5	W
		2.9	W
Junction Temperature	Tj	150	°C
Storage Temperature	Tstg	-55 to +150	°C

*1Pulse width limited by maximum junction temperature.

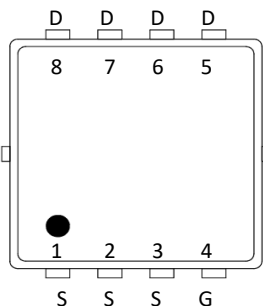
*2The value of RthJA is measured with the device mounted on 1in² FR-4 board with 2oz. Copper, in a still air environment with TA=25°C.

*3The Power dissipation is based on RthJA t ≤ 10s value.

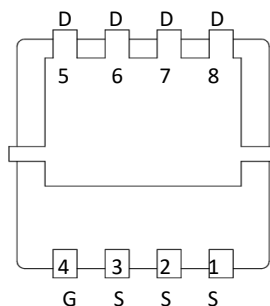
Thermal Characteristics (Typical)

Parameter	Symbol	TYP	Unit
Junction-to Ambient (T _A =25°C)			
t ≤ 10s	R _{thJA} *2	22.0	°C/W
Steady-State		54.0	°C/W
Junction-to Case (T _C =25°C)			
Steady-State	R _{thJC}	1.90	°C/W

Top View



Bottom View



1,2,3: Source
4: Gate
5,6,7,8: Drain

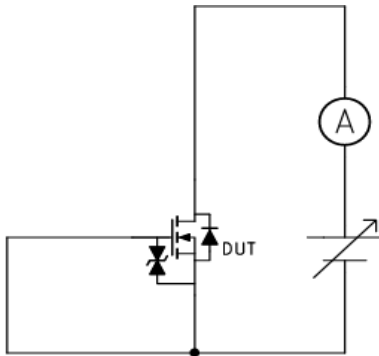
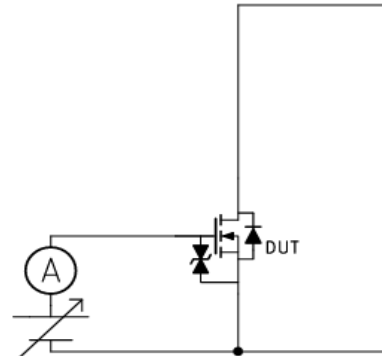
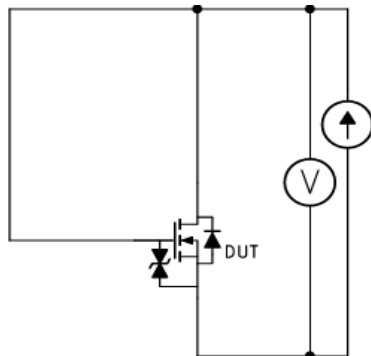
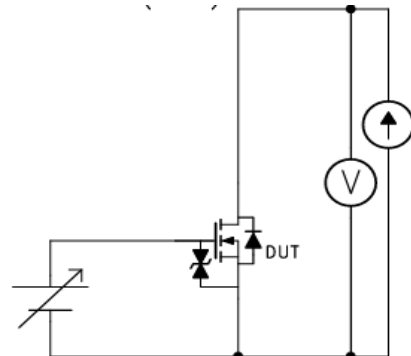
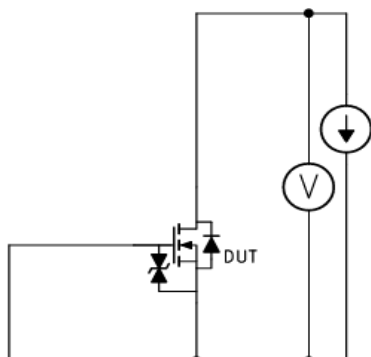
Electrical Characteristics (Tj=25°C)

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Drain-Source Breakdown Voltage	VDSS	ID=250μA, VGS=0V	30			V
Zero Gate Voltage Drain Current	IDSS	VDS=24V, VGS=0V			1	μA
Gate-Source Leakage Current	IGSS	VGS=±20V, VDS=0V			±10	μA
Gate-Source Threshold Voltage	Vth	VDS=VGS, ID=250μA	1.2	1.7	2.4	V
Drain-Source On-State Resistance	RDS(on)1	ID=20A, VGS=10V		2.1	2.8	mΩ
	RDS(on)2	ID=20A, VGS=4.5V		3.5	5.2	
Forward Transconductance	gFS	VGS=5V, ID=20A		110		S
Input Capacitance *1	Ciss	VDS=15V, VGS=0V, f=1MHz		1,845		pF
Output Capacitance *1	Coss			1,470		
Reverse Transfer Capacitance *1	Crss			92		
Gate Resistance *1	Rg	f=1MHz		8		Ω
Turn-On Delay Time *1 *2	td(on)	VDD=15V, VGS=10V, ID=20A		9		ns
Rise Time *1 *2	tr			5		
Turn-Off Delay Time *1 *2	td(off)	VDD=15V, VGS=10V, ID=20A		57		ns
Fall Time *1 *2	tf			38		
Total Gate Charge *1	Qg	VDD=15V, VGS=10V, ID=20A		32.0		nC
Gate-Source Charge *1	Qgs			5.6		
Gate-Drain Charge *1	Qgd			8.0		
Diode Forward Voltage	VSD	IS=1A, VGS=0V		0.7	1.0	V
Maximum Body Diode Continuous Current	IS				46	A
Body Diode Reverse Recovery Time *1	trr	IF=20A, di/dt=100A/μs		44		ns
Body Diode Reverse Recovery Charge *1	Qrr			35		nC

Note *1 Guaranteed by Design

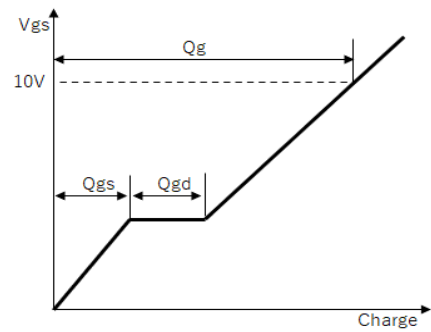
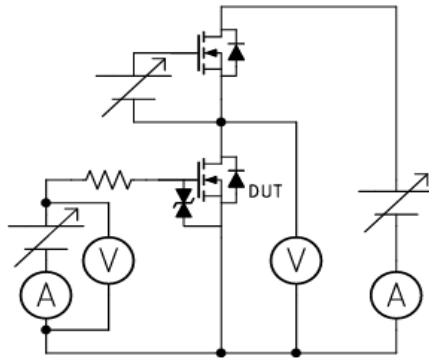
Note *2 Measurement Circuit for Switching Characteristics

Test circuits

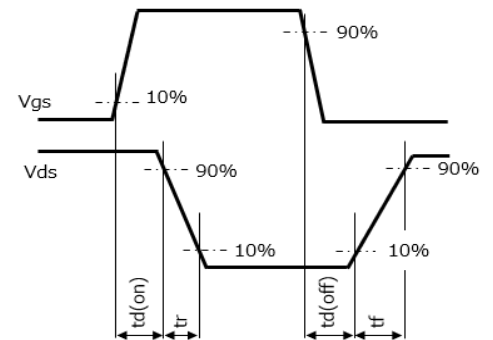
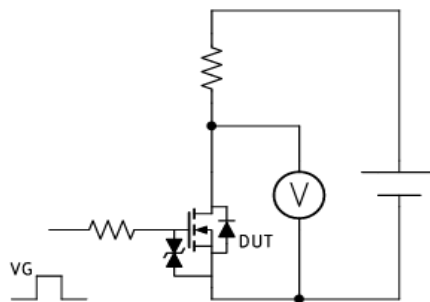
 Test Circuit 1
 V_{DS}/I_{DSS}

 Test Circuit 2
 I_{GSS}

 Test Circuit 3
 V_{th}

 Test Circuit 4
 $R_{DS(on)}$

 Test Circuit 5
 V_F


Test circuits

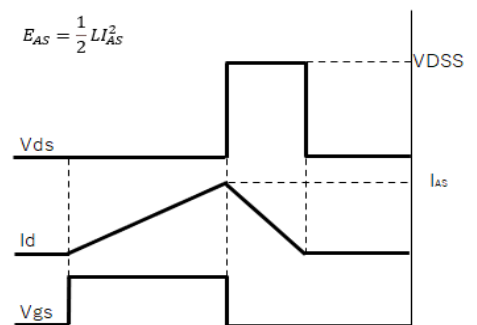
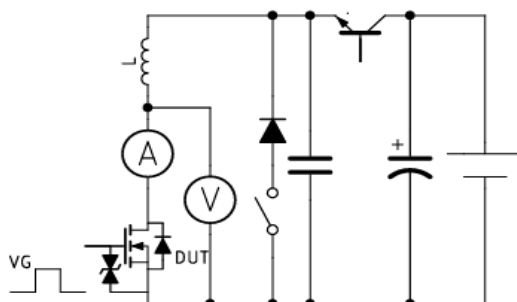
Test Circuit 6
Qg



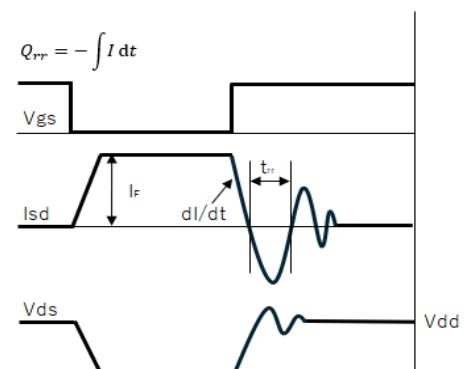
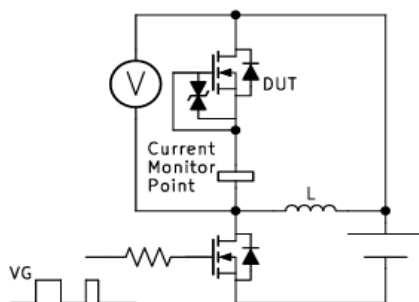
Test Circuit 7
Switching Time

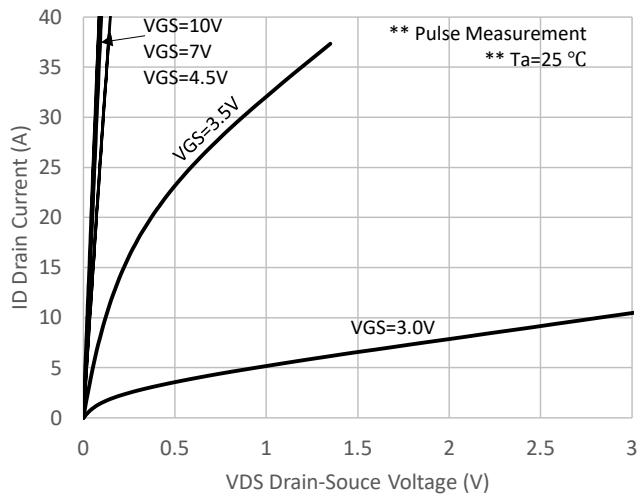
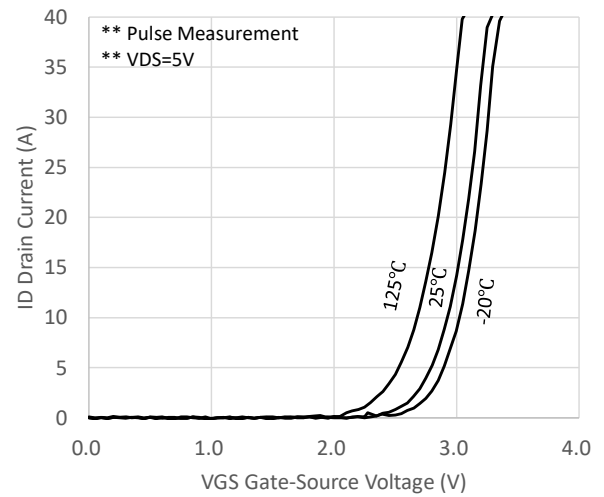
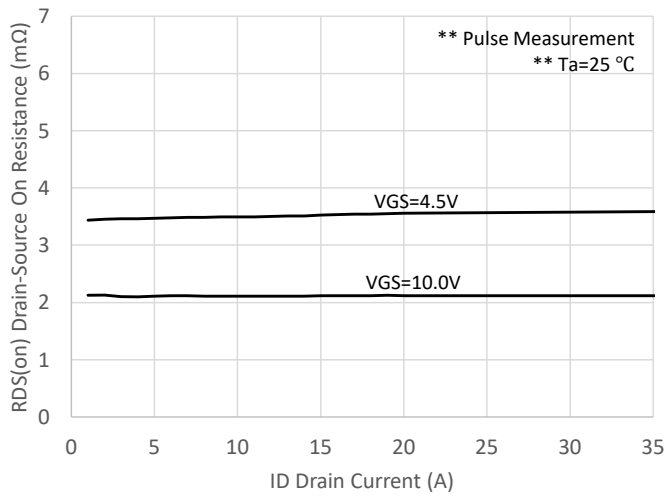
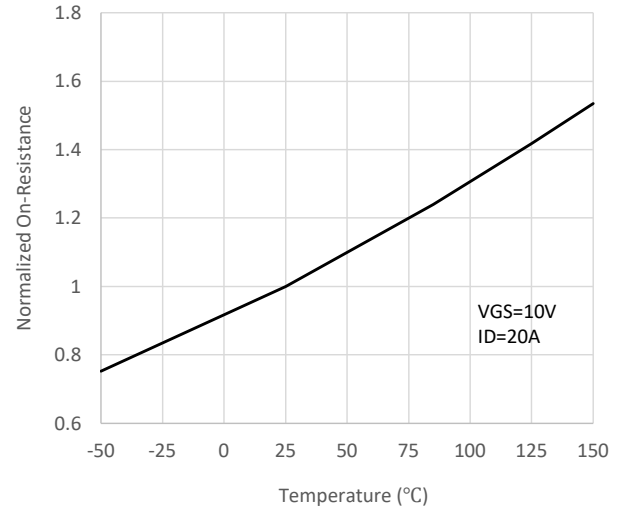
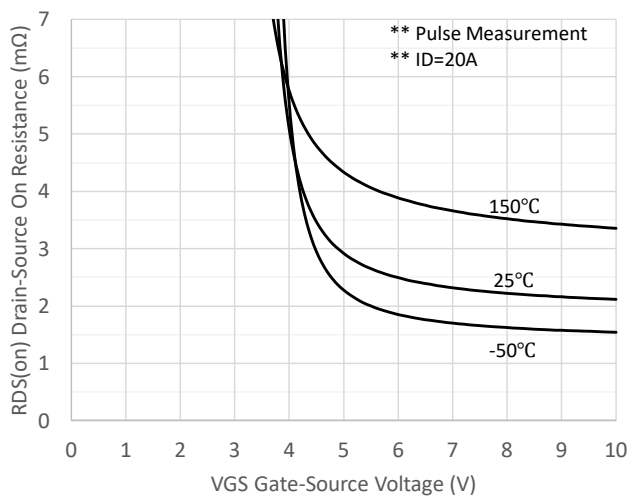
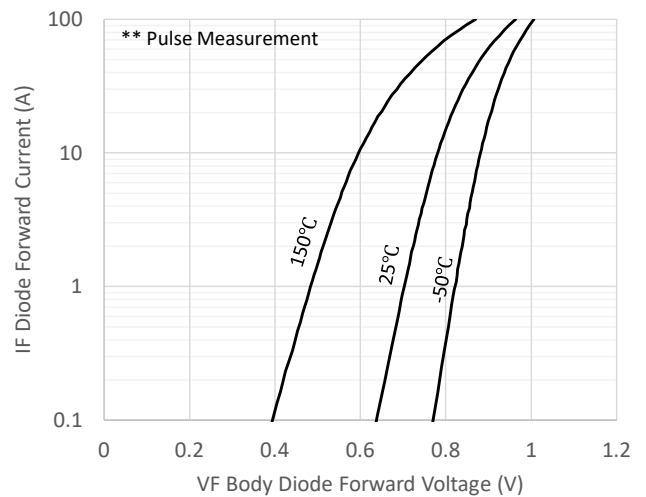


Test Circuit 8
IAS



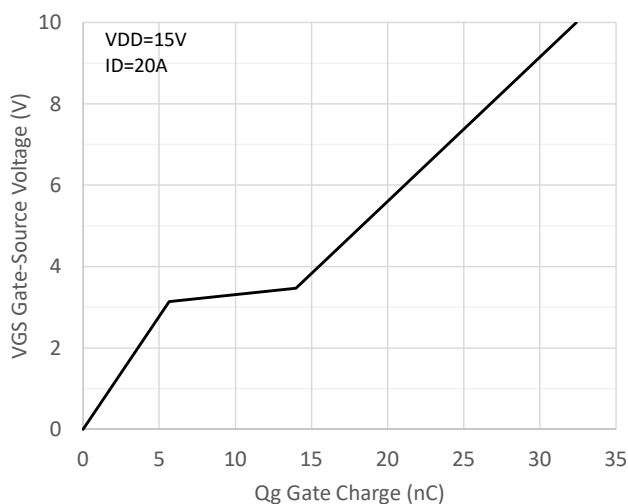
Test Circuit 9
trr/Qrr



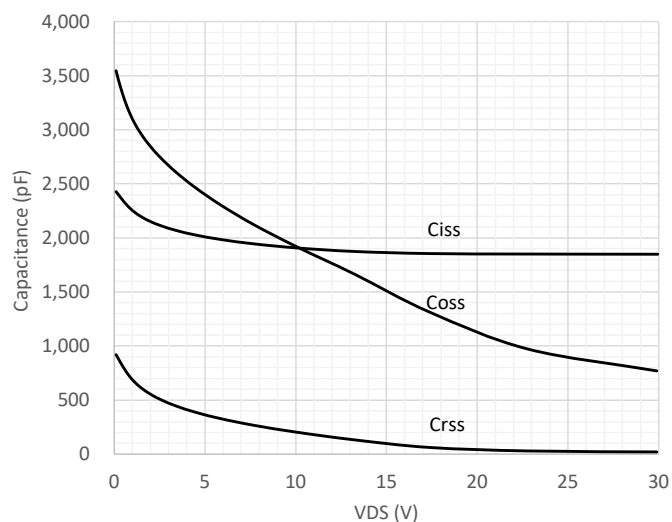
Technical data
ID to VDS

ID to VGS

RDS(on) to ID

On-Resistance vs Junction Temperature

RDS(on) to VGS

IF to VF


Technical data

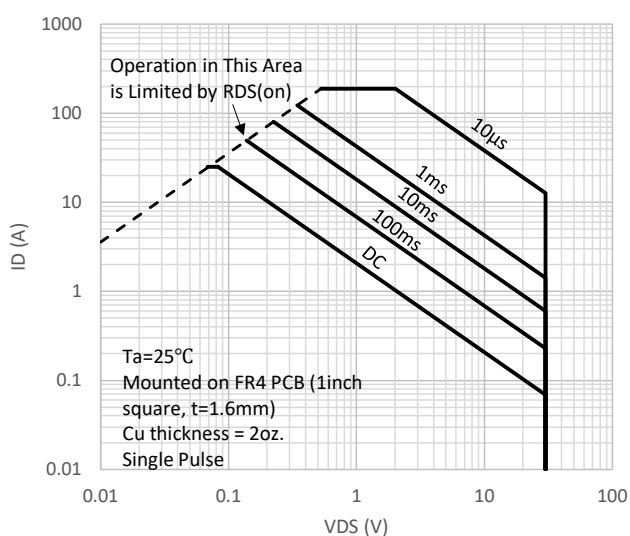
Gate-Charge Characteristics



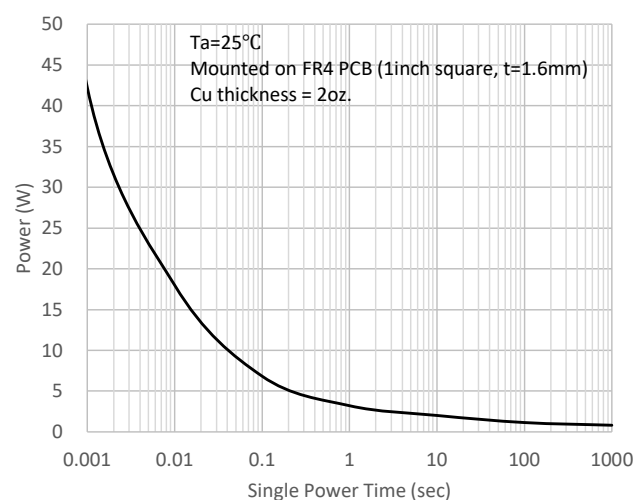
Capacitance Characteristic



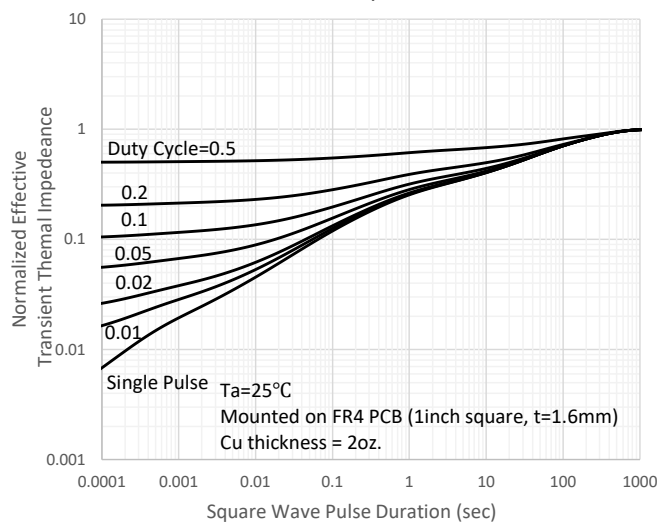
SOA



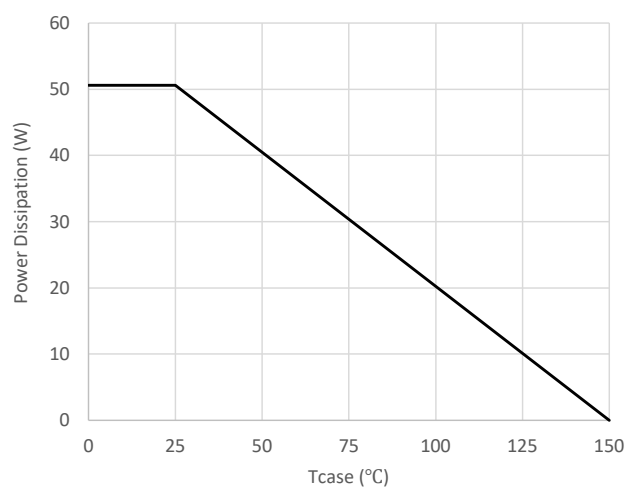
Single Pulse Maximum Power Dissipation

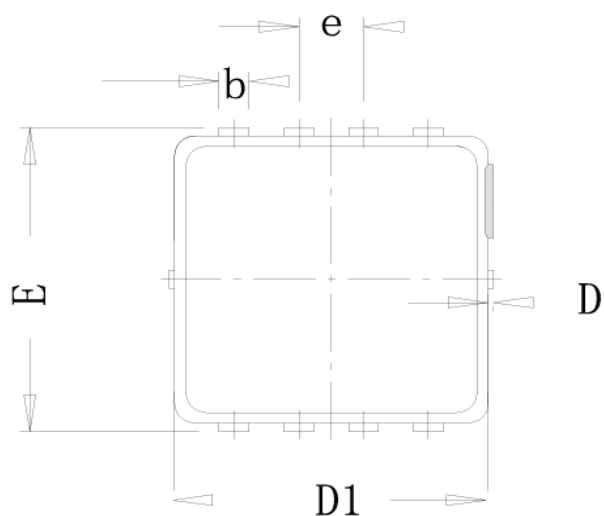
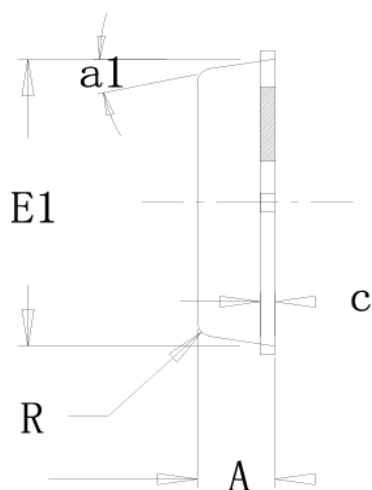
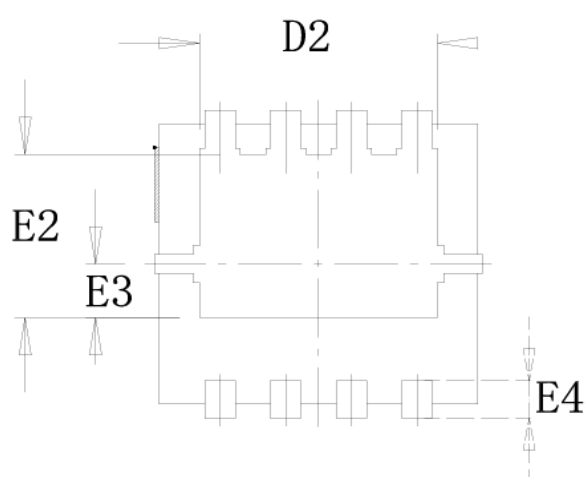


Thermal Response



Power Derating



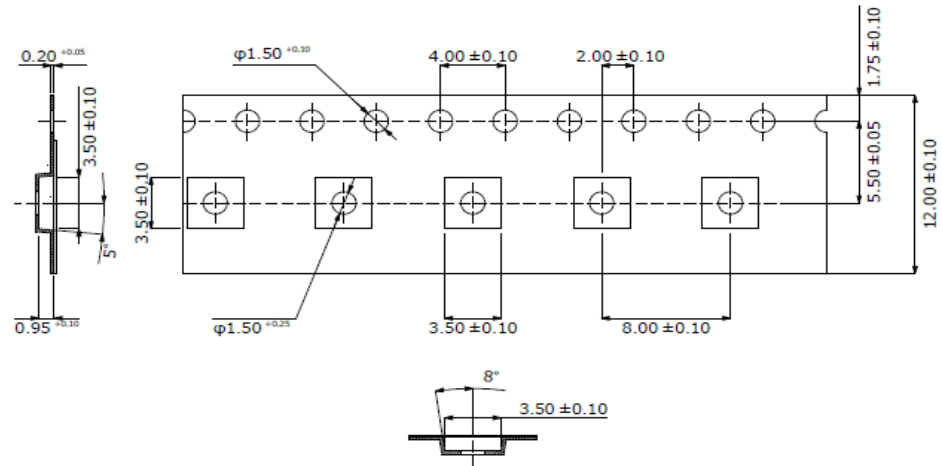
Package Outline Dimensions
Top View

Side View

Bottom View


SYMBOL	MILLIMETER		
	MIN	NOM	MAX
A	0.750	0.780	0.810
* b	0.250	0.300	0.350
c	---	0.152	---
* D	0.000	0.050	0.100
D1	3.120	3.150	3.180
* D2	---	2.590	---
* E	3.200	3.300	3.400
E1	3.090	3.120	3.150
E2	---	1.740	---
E3	---	0.440	---
* E4	---	0.330	---
R	---	0.150	---
* e	0.65BSC		
a1°	---	12°	---

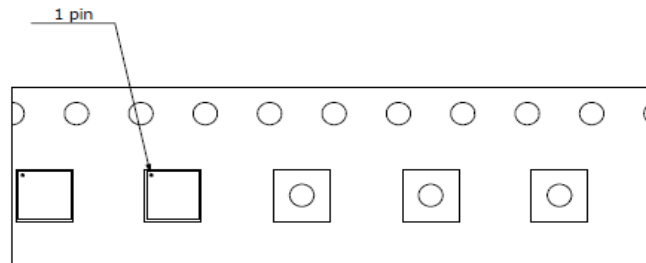
Form

- ❖ Tape & Reel Embossed Type: 5,000pcs / reel
- ❖ Factory PKG Code: PDFN
- ❖ Tape Width: 12mm, Pitch: 8mm, Reel Size: 12inch

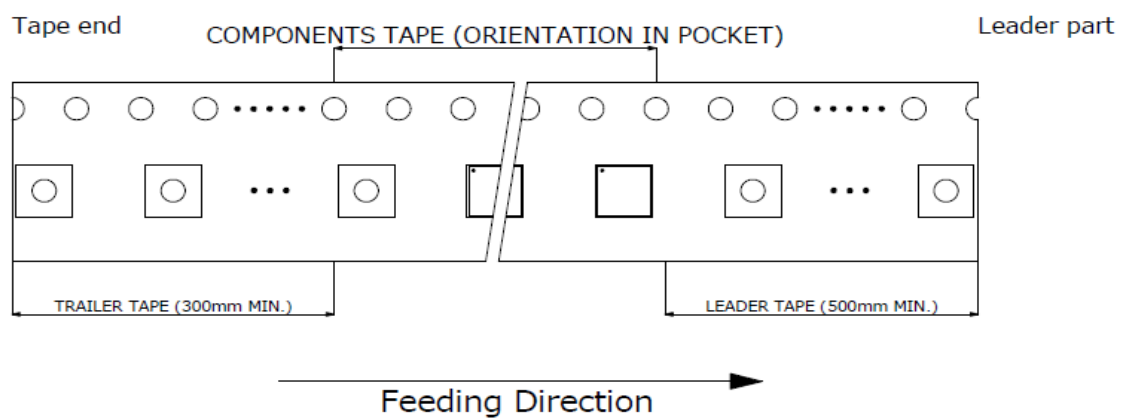
Tape size (mm)



Pin1 Direction



Tape end ~ Leader part (mm)



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